

## Product Summary

$V_{(BR)DSS}$	$R_{DS(ON)} \text{ Max}$	$I_D \text{ Max}$ $T_C = +25^\circ\text{C}$
60V	50m $\Omega$ @ $V_{GS} = 10\text{V}$	16.7A
	65m $\Omega$ @ $V_{GS} = 4.5\text{V}$	14.6A

## Features and Benefits

- Rated to +175°C – Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching – Ensures More Reliable and Robust End Application
- Low  $R_{DS(ON)}$  – Minimizes Power Losses
- Low  $Q_G$  – Minimizes Switching Losses
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. “Green” Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

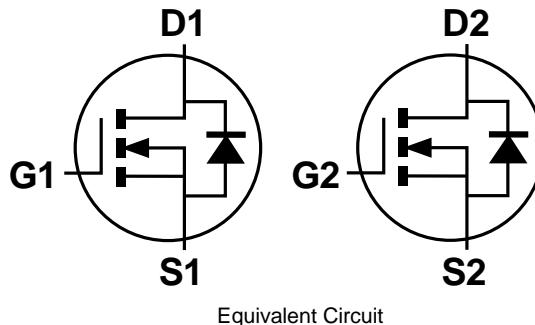
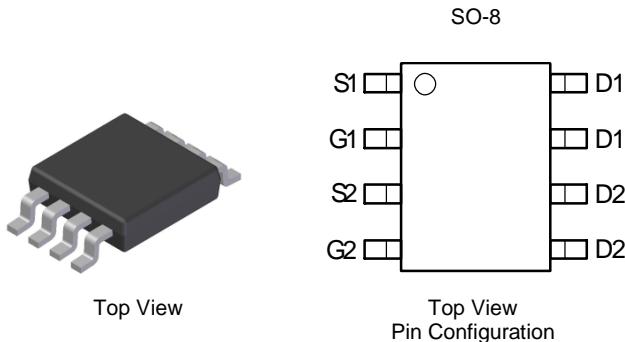
## Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Engine Management Systems
- Body Control Electronics
- DC-DC Converters

## Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.  
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe.  
Solderable per MIL-STD-202, Method 208 **e3**
- Weight: 0.076 grams (Approximate)



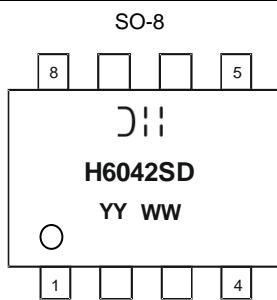
## Ordering Information (Note 5)

Part Number	Case	Packaging
DMNH6042SSDQ-13	SO-8	2,500/Tape & Reel

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to [http://www.diodes.com/quality/product\\_compliance\\_definitions.html](http://www.diodes.com/quality/product_compliance_definitions.html).
5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



○ !! = Manufacturer's Marking  
H6042SD = Product Type Marking Code  
YYWW = Date Code Marking  
YY = Year (ex: 16 = 2016)  
WW = Week (01 - 53)

Maximum Ratings (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			$V_{DSS}$	60	V
Gate-Source Voltage			$V_{GSS}$	$\pm 20$	V
Continuous Drain Current (Note 7) $V_{GS} = 10\text{V}$	Steady State	$T_A = +25^\circ\text{C}$ $T_A = +70^\circ\text{C}$	$I_D$	5.3 4.4	A
	Steady State	$T_C = +25^\circ\text{C}$ $T_C = +100^\circ\text{C}$	$I_D$	16.7 14	A
Pulsed Drain Current (10 $\mu\text{s}$ Pulse, Duty Cycle = 1%)			$I_{DM}$	35	A
Maximum Continuous Body Diode Forward Current (Note 7)			$I_S$	2.3	A
Avalanche Current (Note 8) $L = 10\text{mH}$			$I_{AS}$	3.5	A
Avalanche Energy (Note 8) $L = 10\text{mH}$			$E_{AS}$	65	$\text{mJ}$

## Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 6)		$P_D$	1.5	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State $t < 10\text{s}$	$R_{\theta JA}$	100	$^\circ\text{C/W}$	
			61		
Total Power Dissipation (Note 7)		$P_D$	2.1	W	
Thermal Resistance, Junction to Ambient (Note 7)	Steady State $t < 10\text{s}$	$R_{\theta JA}$	72	$^\circ\text{C/W}$	
			44		
Thermal Resistance, Junction to Case (Note 7)		$R_{\theta JC}$	7.25		
Operating and Storage Temperature Range		$T_J, T_{STG}$	-55 to +175	$^\circ\text{C}$	

 Electrical Characteristics (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS (Note 9)</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	60	—	—	V	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$
Zero Gate Voltage Drain Current $T_J = +25^\circ\text{C}$	$I_{DSS}$	—	—	1	$\mu\text{A}$	$V_{DS} = 60\text{V}, V_{GS} = 0\text{V}$
Gate-Source Leakage	$I_{GSS}$	—	—	$\pm 100$	nA	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$
<b>ON CHARACTERISTICS (Note 9)</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	1.0	—	3.0	V	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$
Static Drain-Source On-Resistance	$R_{DS(ON)}$	—	34	50	$\text{m}\Omega$	$V_{GS} = 10\text{V}, I_D = 5.1\text{A}$
		—	45	65		$V_{GS} = 4.5\text{V}, I_D = 4.4\text{A}$
Diode Forward Voltage	$V_{SD}$	—	0.8	1.2	V	$V_{GS} = 0\text{V}, I_S = 2.6\text{A}$
<b>DYNAMIC CHARACTERISTICS (Note 10)</b>						
Input Capacitance	$C_{ISS}$	—	584	—	pF	$V_{DS} = 25\text{V}, V_{GS} = 0\text{V}, f = 1.0\text{MHz}$
Output Capacitance	$C_{OSS}$	—	83	—	pF	
Reverse Transfer Capacitance	$C_{RSS}$	—	24	—	pF	
Gate Resistance	$R_G$	—	3.8	—	$\Omega$	$V_{DS} = 0\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$
Total Gate Charge ( $V_{GS} = 4.5\text{V}$ )	$Q_G$	—	4.2	—	nC	$V_{DS} = 44\text{V}, I_D = 5.2\text{A}$
Total Gate Charge ( $V_{GS} = 10\text{V}$ )	$Q_G$	—	8.8	—	nC	
Gate-Source Charge	$Q_{GS}$	—	1.8	—	nC	
Gate-Drain Charge	$Q_{GD}$	—	1.8	—	nC	
Turn-On Delay Time	$t_{D(ON)}$	—	3.4	—	ns	$V_{GS} = 10\text{V}, V_{DS} = 30\text{V}, R_G = 6\Omega, I_D = 1\text{A}$
Turn-On Rise Time	$t_R$	—	1.9	—	ns	
Turn-Off Delay Time	$t_{D(OFF)}$	—	10.1	—	ns	
Turn-Off Fall Time	$t_F$	—	4.5	—	ns	
Body Diode Reverse Recovery Time	$t_{RR}$	—	12.9	—	ns	$I_F = 2.6\text{A}, di/dt = 100\text{A}/\mu\text{s}$
Body Diode Reverse Recovery Charge	$Q_{RR}$	—	5.4	—	nC	

Notes:

6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
8.  $I_{AS}$  and  $E_{AS}$  rating are based on low frequency and duty cycles to keep  $T_J = +25^\circ\text{C}$ .
9. Short duration pulse test used to minimize self-heating effect.
10. Guaranteed by design. Not subject to product testing.

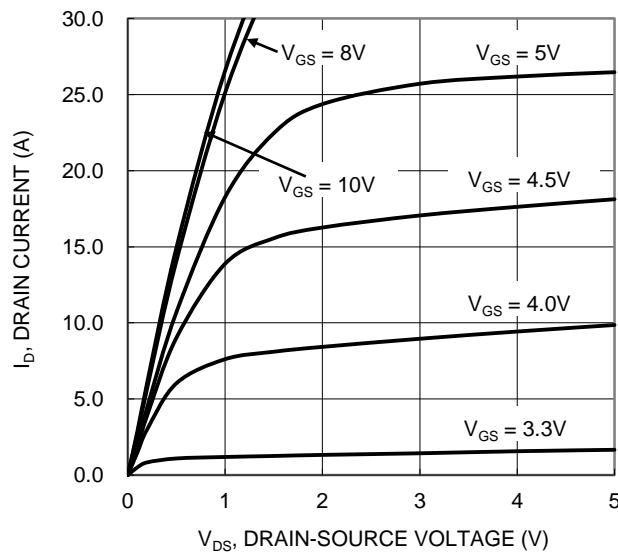


Figure 1. Typical Output Characteristic

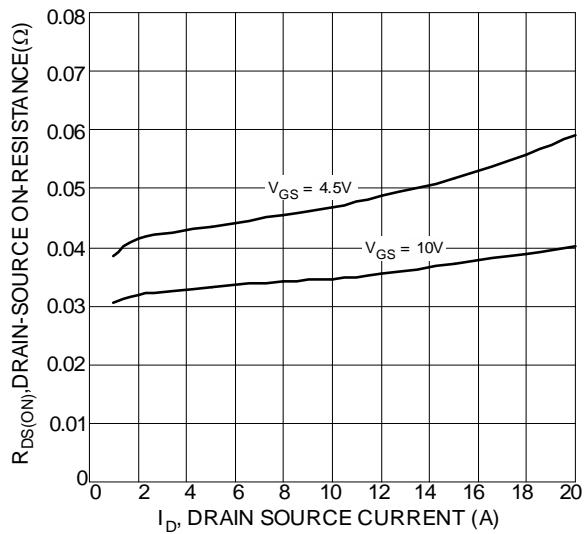


Fig. 3 Typical On-Resistance vs.  
Drain Current and Gate Voltage

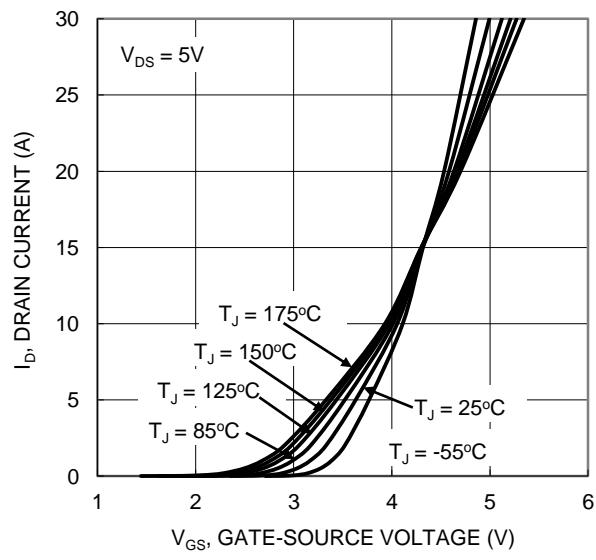


Figure 2. Typical Transfer Characteristic

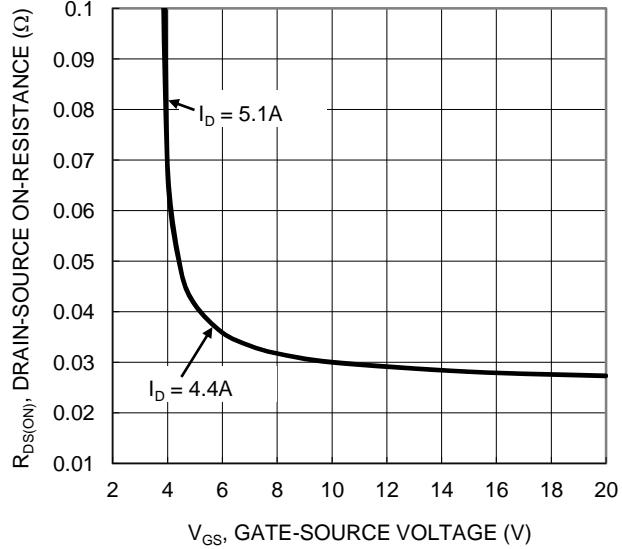


Figure 4. Typical Transfer Characteristic

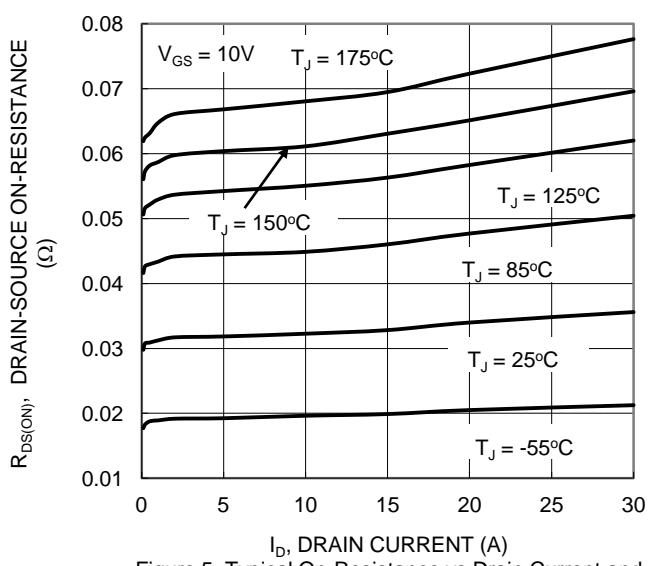


Figure 5. Typical On-Resistance vs Drain Current and  
Temperature

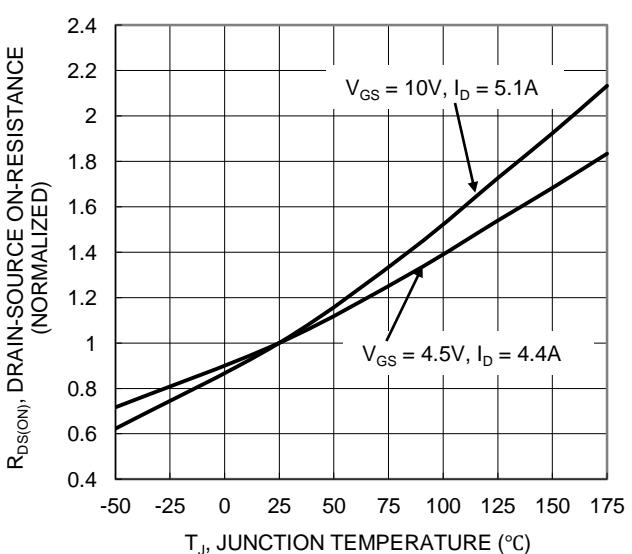
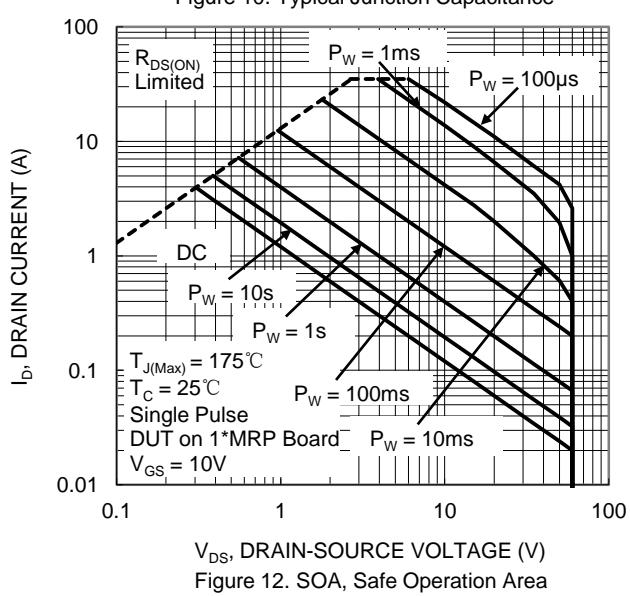
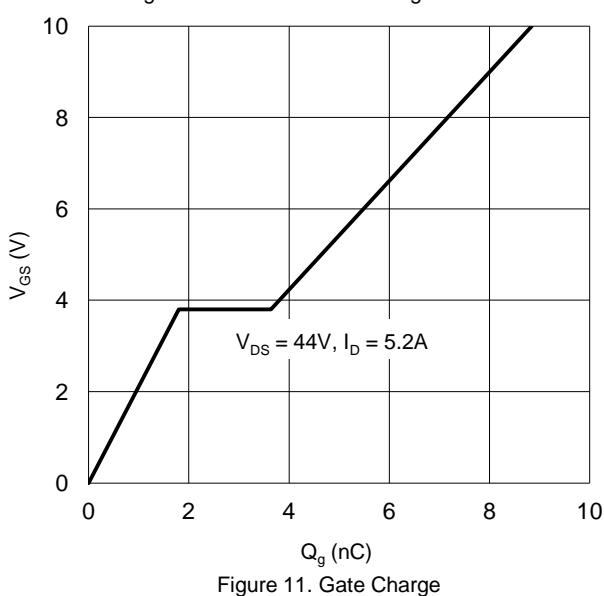
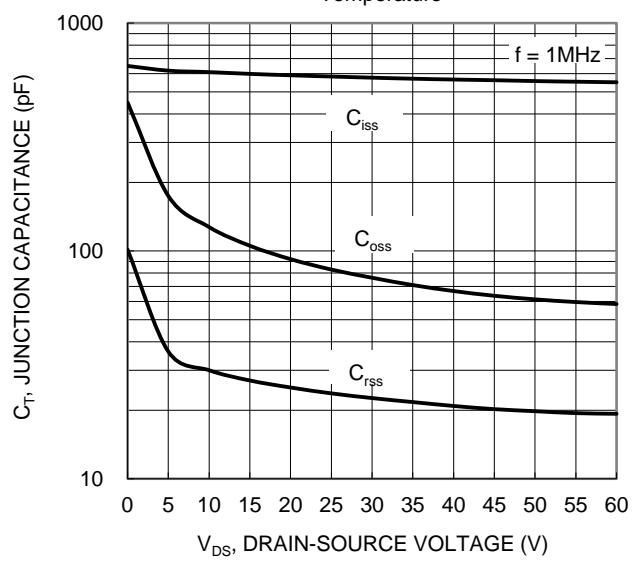
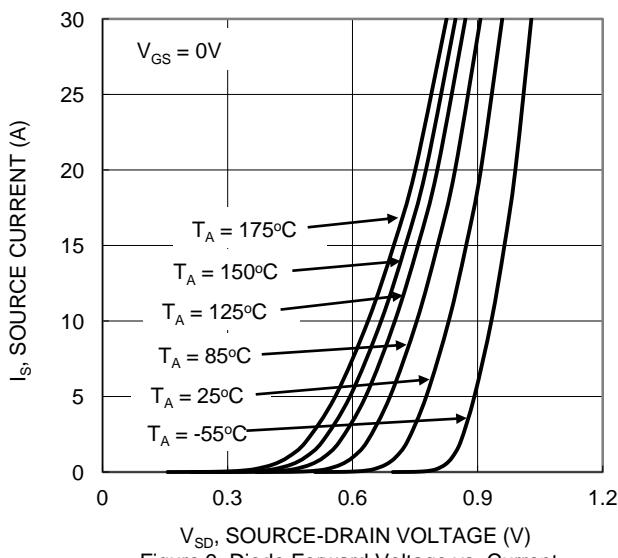
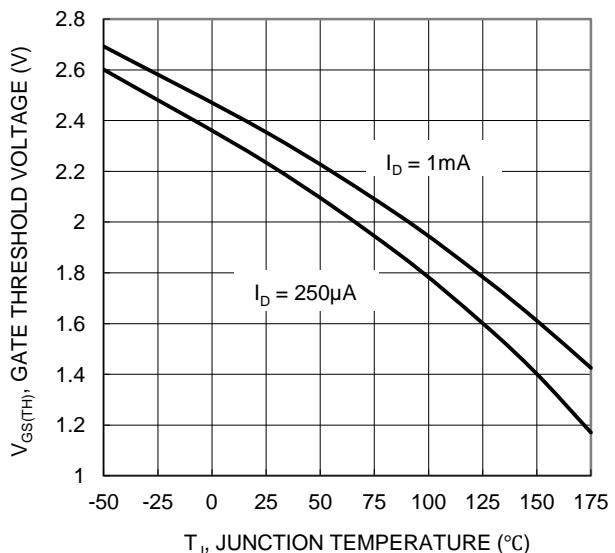
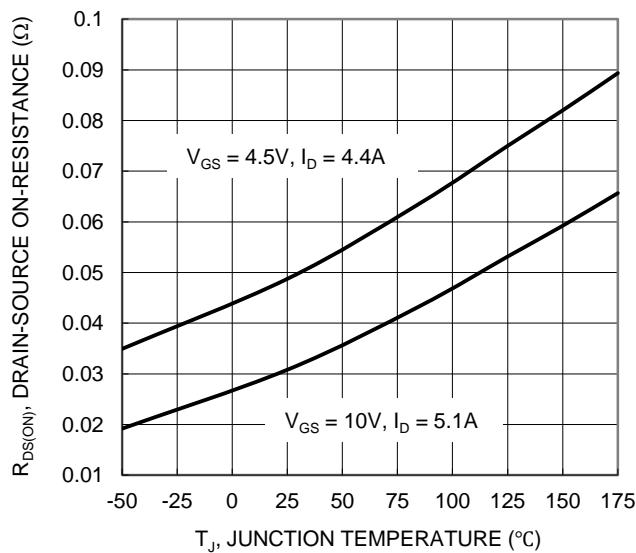


Figure 6. On-Resistance Variation with Temperature



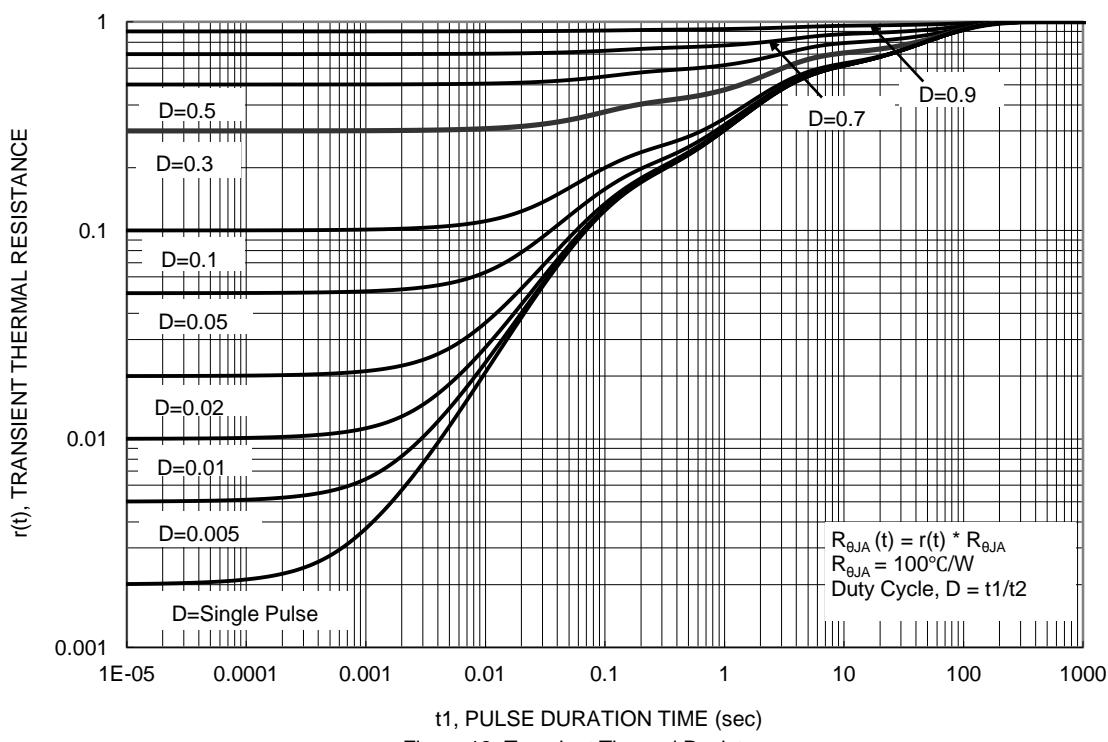
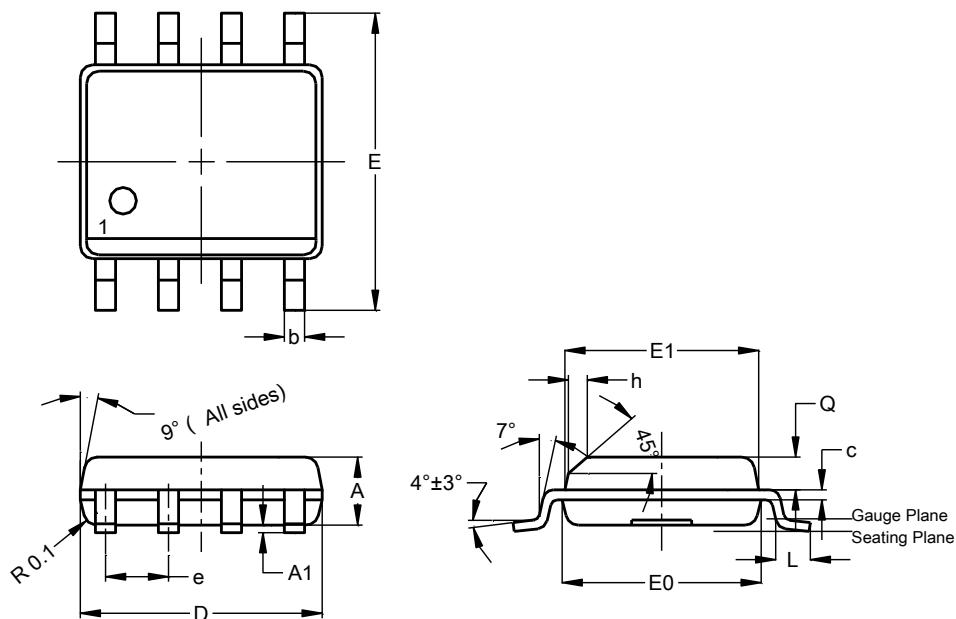


Figure 13. Transient Thermal Resistance

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SO-8



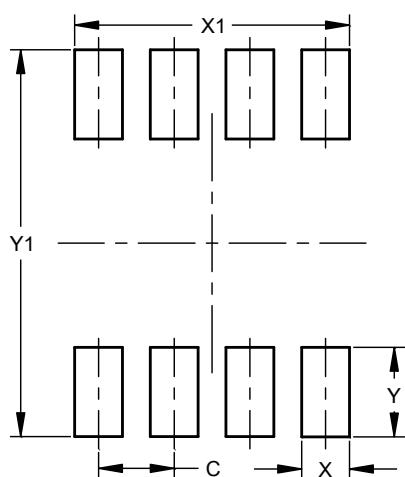
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Dim	Min	Max	Typ
<b>A</b>	1.40	1.50	1.45
<b>A1</b>	0.10	0.20	0.15
<b>b</b>	0.30	0.50	0.40
<b>c</b>	0.15	0.25	0.20
<b>D</b>	4.85	4.95	4.90
<b>E</b>	5.90	6.10	6.00
<b>E1</b>	3.80	3.90	3.85
<b>E0</b>	3.85	3.95	3.90
<b>e</b>	—	—	1.27
<b>h</b>	—	—	0.35
<b>L</b>	0.62	0.82	0.72
<b>Q</b>	0.60	0.70	0.65

All Dimensions in mm

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SO-8



Dimensions	Value (in mm)
<b>C</b>	1.27
<b>X</b>	0.802
<b>X1</b>	4.612
<b>Y</b>	1.505
<b>Y1</b>	6.50

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